



Impact of Big Data on SoC Design

IoT Technology and SoC Design

Chun-Zhang Chen, Ph.D.

June 25-29, 2018



中国科学院大学**2018**年夏季

IoT and SoC Design

IoT and Technology Background



IoT and LPWAN



IoT and MCU/IP



3D IC/MEMS/Wearable

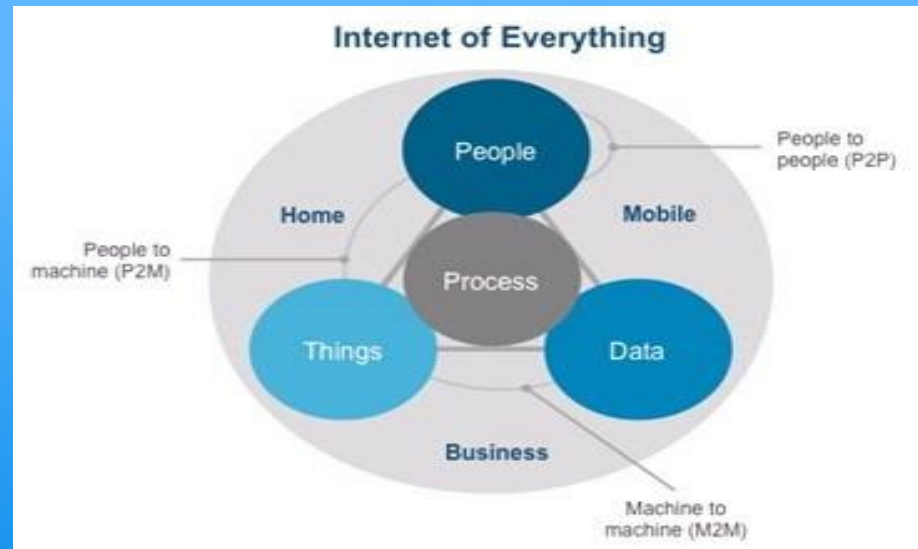


Discussion



Hot Topics of IoT

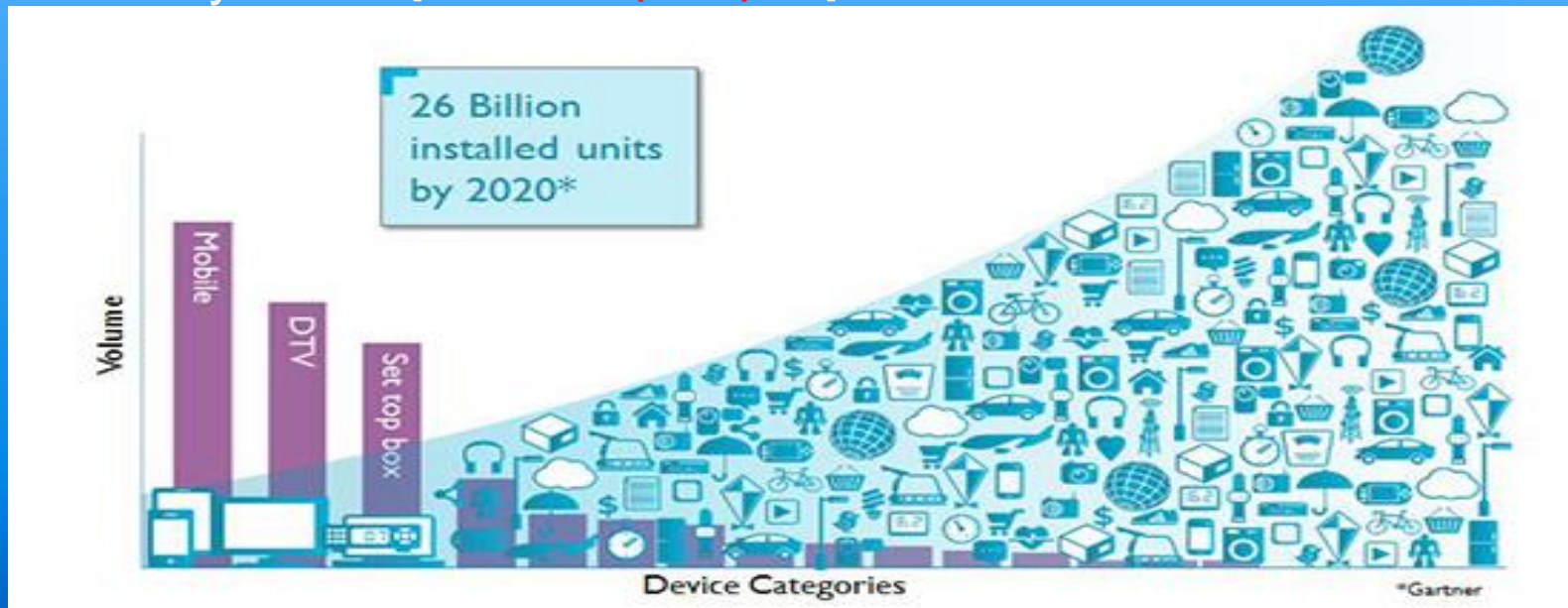
- Internet of (for) Things – IoT
 - P2P, M2M, P2M
 - Billion Things/ Everything
 - Internet of Vehicles
- IoT Applications
 - Consumer: SHome, Med/Hlth
 - Enterprise/biz: Devices
 - Infrastructure: Manuf., Agr. E./Env.
- Internet+, Ind. IoT (IIoT)
 - Green Energy/Smart Grid
 - 3rd/4th Industrial Revolution



Connected Devices in 2020

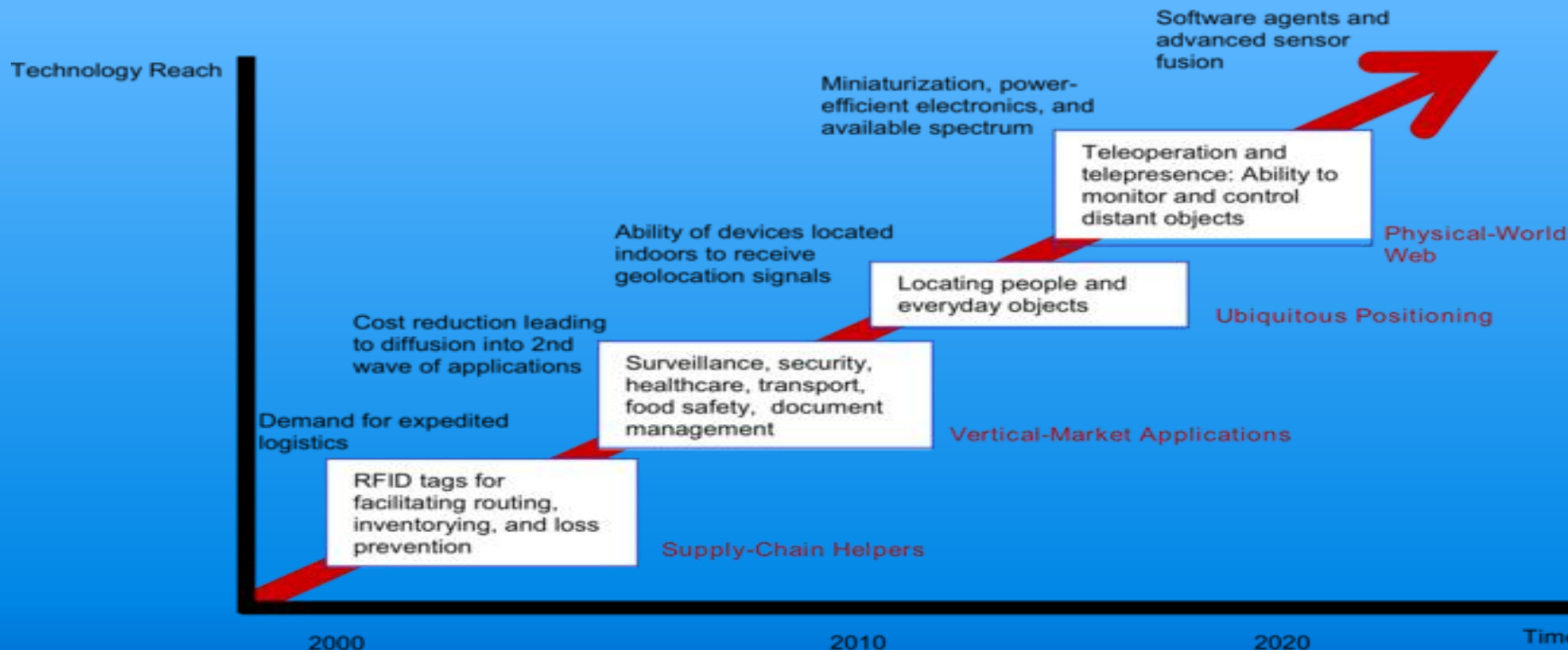


- Gartner, Inc. forecasts that 4.9 billion connected things will be in use in 2015, up 30 percent from 2014, and will reach 25 billion by 2020. [Ref. 11, **12(IEEE)**, 13]



Technology Roadmap of IoT

TECHNOLOGY ROADMAP: THE INTERNET OF THINGS



Source: SRI Consulting Business Intelligence

The Internet of Things

12-13 May 2015, San Francisco,

Essential IoT Training Program alongside Internet of Things World 2015

Telecoms Academy
TRAINING EXCELLENCE

2ND ANNUAL
Internet
of Things
WORLD

my of Sciences

- The world's largest & most comprehensive IoT event
- 4000+ Attendees
- 250+ Speakers
- High Level VIP/CIOs Conference

Internet of Things
Internet of Your Things
Internet of Every Things

Integrating IoT Technologies and Standards & Creating a Sustainable IoT Framework

- ◆ Assessing the range of enabling technologies for IoT
- ◆ Overcoming interoperability challenges
- ◆ Which wireless standards will be most pertinent
- ◆ How can the different standards be integrated?

8th Int'l Conference on IoT

Keynote Speakers

- **IoT 2018 (Santa Barbara, US)**

- *SmartFarm, UCSB*
- IoT 2017 (Linz, Austria)
- IoT 2016 (Stuttgart, Germany)
- IoT 2015 (Coex, Seoul, S. Korea)
- IoT 2014 (MIT, Cambridge, US)
- IoT 2012 (Wuxi, China)
- IoT 2010 (Tokyo, Japan)
- IoT 2008 (Zurich, Switzerland)

- **IoT Asia 2019, 27-28 Mar. S'pore**

- IoT Asia 2018, 21-22 Mar. S'pore
- IoT Asia 2017, 29-30 Mar. S'pore
- IoT Asia 2016, 30-31 Mar. S'pore
- IoT Asia 2015, 8-9 April, Singapore
- IoT Asia 2014, 21-22 April, S'pore
- *IoT China 2016, 16-18 Nov, CD*
- *IoT Expo China 2015, 20-21 Aug, SZ*

www.iot-conference.org

DAC and IoT

San Francisco, CA June 24-28, 2018

DAC 2018 | San Francisco, CA | June 24-28

About DAC

Exhibit At DAC

- Design
- EDA
- ESS and Auto
- IoT
- IP
- Security

MONDAY KEYNOTE



Living Products: Building Connected Devices that Learn and Evolve

Monday, June 25 | 9:20am - 10:00am | Room 3008

Sarah Cooper, GM of IoT Solutions

Amazon Web Services, Inc., Mountain View, CA

- Rikky Muller, UCB

The Internet of Things can sometimes seem vast and unmanageable, ...

Design ▶

There is no other way to improve your "design IQ" in such a short amount of time than to attend the Design Track.

EDA ▶

In addition to the traditional EDA topics ranges from physical design to system architectures, DAC 2016 features high-quality papers on design research, design practices, and design automation for...

ESS & Auto ▶

The Embedded Systems and Software sessions at DAC provide a forum for discussing the challenges of embedded design and an opportunity for leaders in the industry and academia to come together to...

IoT ▶

The Internet of Things can sometimes seem vast and unmanageable. Let the IoT sessions at DAC simplify it for you.

IP ▶

The IP track provides creators and users of IP with an open forum to exchange information on state-of-art IP products, tools and methodologies to create, incorporate and validate IP in SoCs.

Security ▶

Security topics will be featured through invited special sessions, panels, and lecture/poster presentations by both practitioners and researchers to share their knowledge and experience on this...

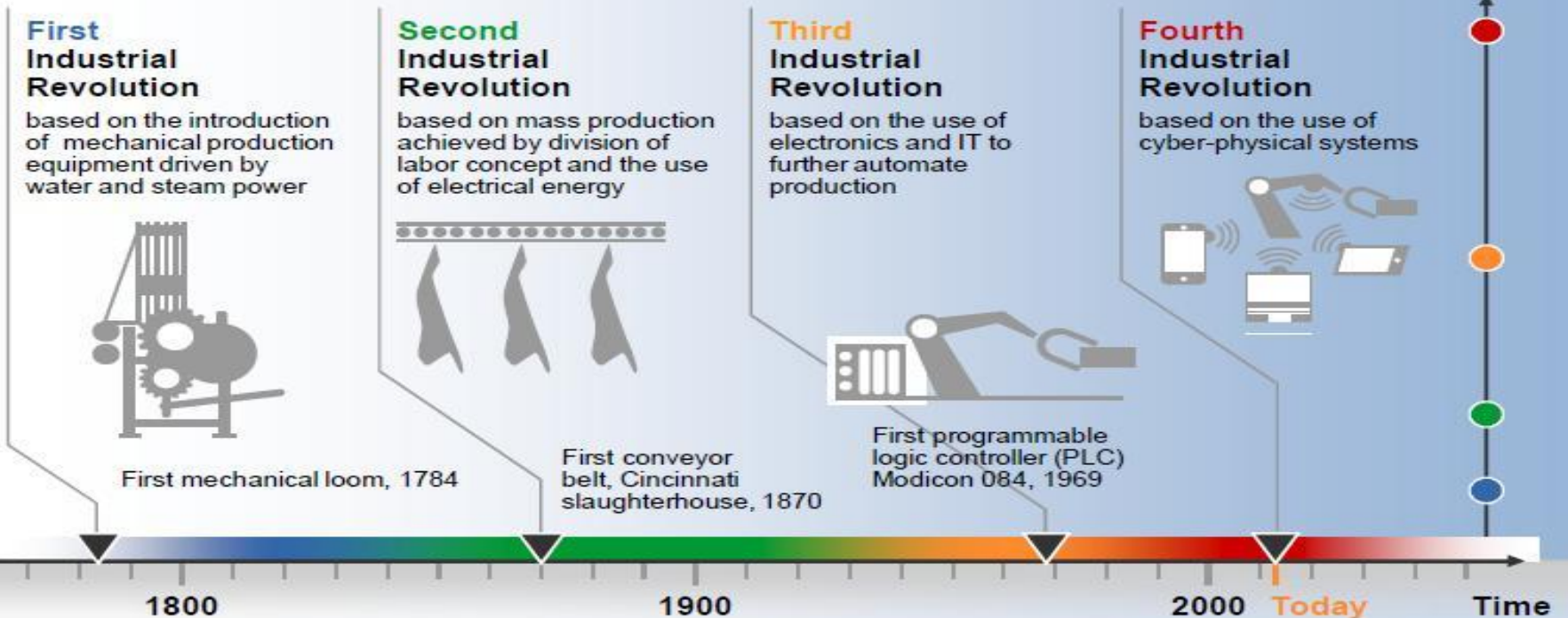
IMS – Intelligent Manufacturing System

- IM in US, 1980s; IMS (1990) by Andrew Kusiak (U. Iowa)
 - “Big Data on IM” (8/6/14 at UCAS); ANN for IMS
- Industry 4.0 in Germany (IP/IoT)
- 02/2014, Made in China 2025 – 2035 – 2049
- IMS and associated topics
 - Journal, Research & Business, Solution, Software

The Third | Fourth Industrial Revolution

Jeremy Rifkin, 2011

From Industry 1.0 to Industry 4.0





- **Background of IoT Tech:** Internet of Things
- **IoT and LPWAN:** NB-IoT, IPv6
- **IoT and MCU/IP:** Low Power & Size, 3D NAND
- **3D IC/MEMS/Wearable:** Healthcare/Medical, Fitness/Wellness
- **Discussion:** Vendors, Players

IoT needed Technologies - LPWAN

- LPWAN: NB-IoT, LoRa, Sigfox
- NB-IoT (2016-, via GPRS)
 - Low data rate, low power, low bandwidth
 - Global 900MHz (UniCom 900/1800MHz, TelComm 800MHz)
 - Registered, SIM/eSIM supported
 - 2G Shutdown in 2018; GPRS/GSM needed in long-term
 - Bandwidth 200kHz,
 - Down 160-250kbps, up 160-250(MT)|200(ST)kbps
 - Connection points is 50-100x of current Wi-Fi
 - 20dB gain, is 100x of LTE

- LoRa (2015)
 - Up to 1000 devices, 5-30km
 - In testing, 100,000 devices?
- Sigfox (2009, Fr.)
- Security by GDPR (General Data Protection Regulation)

- Wi-Fi
 - 2003 Intel, 11 Mbps, 802.11b → 802.11b/g, a/c/n
- BLE/BC (BR, EDR)
 - BR(Basic Rate), EDR(Enhanced Data Rate); BLE(Bluetooth Low-Energy)
 - 1994-1997 Ericsson; 1998 SIG (Nokia, Apple, Samsung)
- ZigBee (2003-), HomeRF (1997), Thread (2014)
- IrDA, RFID-Mifare, Z-wave, UWB, NFC, LiFi

5G Communication



- Mobile Internet
- 5G standards
- SoC and Memory Designs
 - HPC & MEC
 - HBM & RapidIO

IoT and Internet Protocol

Technology, Compatibility and Security

- Total number of IP addresses:
 - IPv4, $2^{32} = 4.3 \times 10^9$
 - IPv6, $2^{128} = 3.4 \times 10^{38}$
- Privacy and Security
- Comparability of Internet Protocol
 - Ex. SIP, Session Initiation Protocol –
 - controlling voice/video over IPv4 → ? IPv6

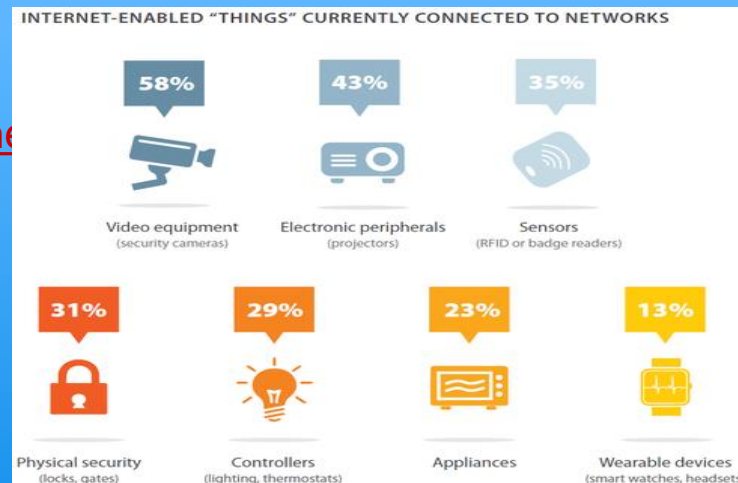
What happened to IPv6 – Will the IoT

- ... we were all supposed to have abandoned IPV4 and moved to IPV6 by now (12/31/14)
- These ‘things’ have been predicted (presumably by the same people who predicted the arrival of IPV6) to grow to an army of **50 billion** by 2020.
- The measurement activities below track different aspects of IPv6 deployment on the global Internet:
 - <http://www.worldipv6launch.org/measurements/>

IPv6 Ready Logo Program

- Spiceworks Report (2014):

- <http://www.spiceworks.com/voit/reports/the>



- As service providers bring IPv6 connectivity to the home, users need to make sure the appliances and other devices they buy are capable of using IPv6 as a transport.

IPv6 for IoT

IPv6 Adoption

We are continuously measuring the availability of IPv6 connectivity among Google users. The graph shows the percentage of users that access Google over IPv6.





- **Background of IoT Tech:** Internet of Things
- **IoT and LPWAN:** NB-IoT, IPv6
- **IoT and MCU/IP:** Low Power & Size, 3D NAND
- **3D IC/MEMS/Wearable:** Healthcare/Medical, Fitness/Wellness
- **Discussion:** Vendors, Players

MCU Market in IoT Applications

- Controller: PCs, SmartPhones
- Basic Framework: Routers and Servos
- Nodes: Video, Traffic Lights, E Appliances

MCU Snapshot - a Platform for IoT

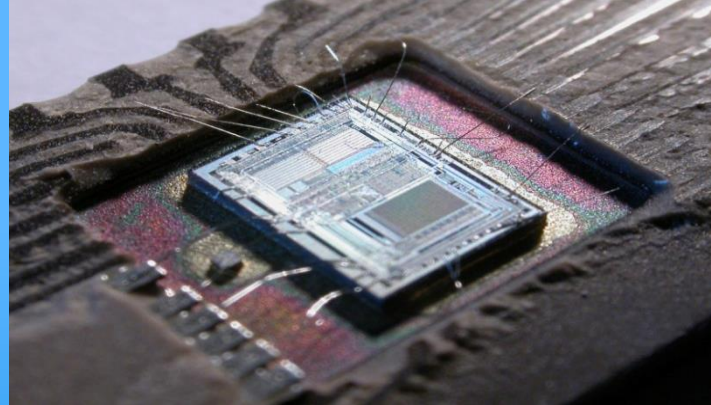
Applications:

Automotive
IoT/Wearables
Appliances
Smart Card
Medical
Industry Control

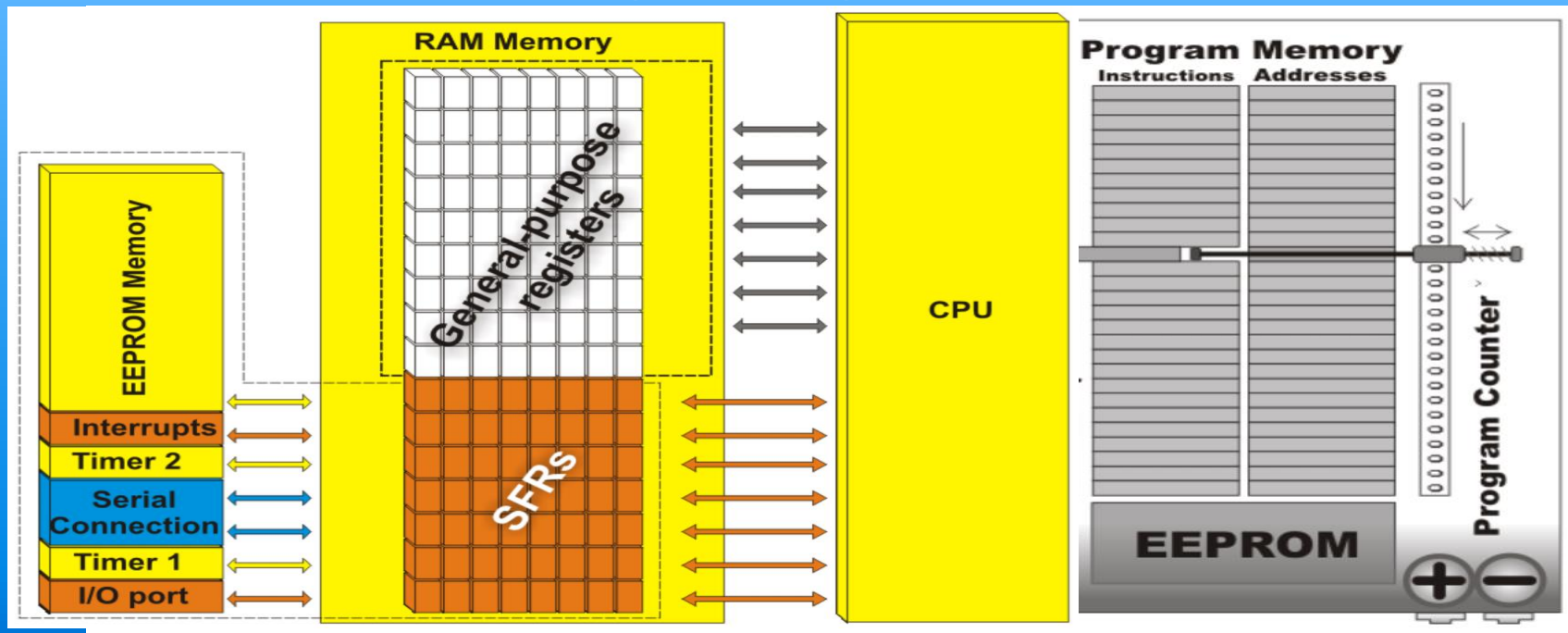
- 1971-1976, Intel 4004 w/ RAM, ROM, MCS-4
 - 4-bit, later 8-bit 8008
- 1976-1980 MCS-48 8-bit CPU parallel I/O etc
 - RAM, ROM, <4kB, w/o serial I/O
- 1980-1983, 16-bit, address 64kB
- 1983-late 80s, 16-bit MCS-96 series, up to 120k transistors
- 1990 applied to many areas
 - measure & control, smart meters, complete set, smart interface
 - mobile, auto GPS, PDA, toys, smart appliance, medical
 - total >100k engineers in China are on MCU

MCU vs MPU

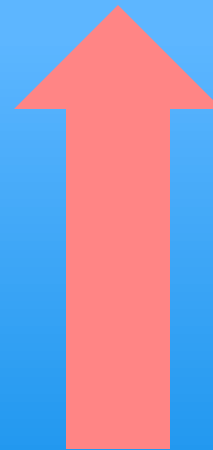
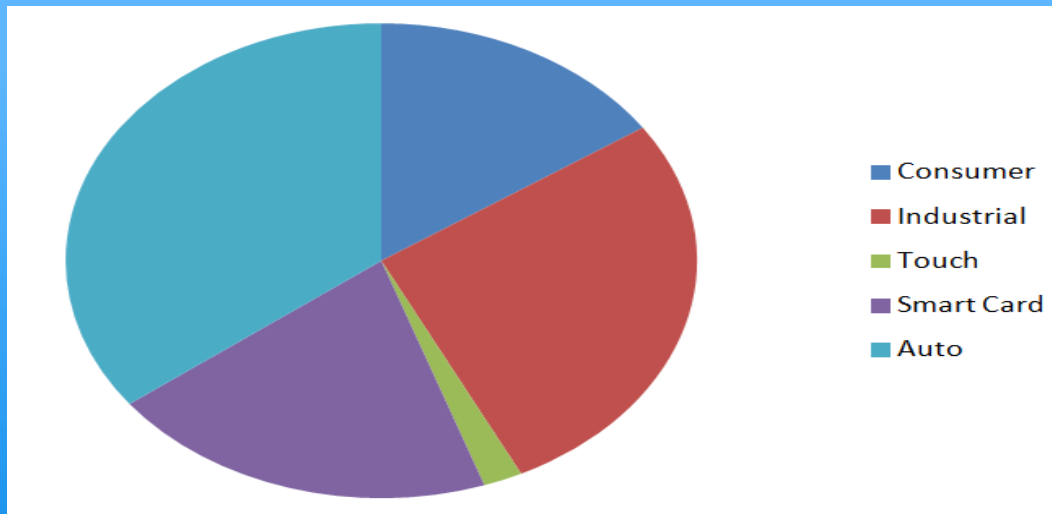
- CPU → MPU, MCU, DSP
- MCU is an embedded design
- The first MCU in 1971, TMS 1000
 - By Gary Boone & Michael Cochran of TI
 - ROM, RAM, processor, clock
- Early MCU has 2 ROM types
 - EPROM, ceramic packg. w/ quartz window
 - PROM (OTP), less expensive
- MCU in 1993 w/ EEPROM and Flash by Atmel
- Used in auto, a mid-range auto has 30+ MCU
 - washing m., microwave o., telephone
- Need programs fit in



● Architecture and Programming of 8051 Microcontrollers



MCU Application in 2013 Market Segment

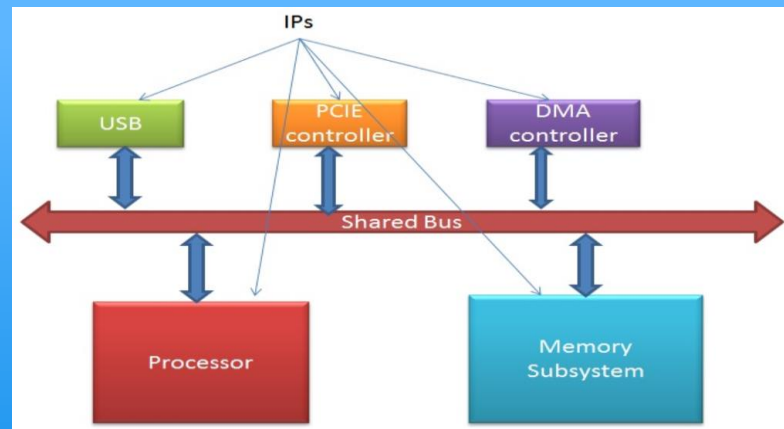


Category	Revenue, \$M
Consumer	2350
Industrial	4112
Touch	303
Smart Card	3026
Auto	5342
Total	15133

Category	Market %
Consumer	15.5
Industrial	27.2
Touch	2
Smart Card	20
Auto	35.3
Total	100

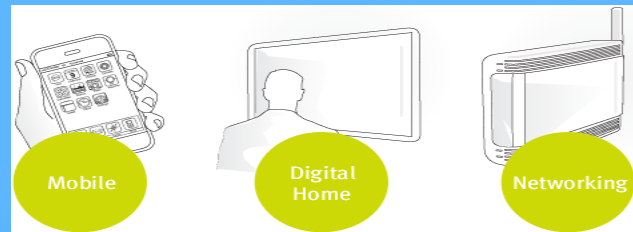
IP for IoT – Design and Reuse

- Analog & Mixed Signal
- Memory Controller & PHY
- Graphic & Peripheral
- Interface Controller & PHY
- Processor & Microcontroller
- Memory & Logic Library
- **Security**
- **Multimedia**
- Wireline Communication
- **Wireless Communication**
- Automotive, Platform Level IP, Network-on-Chip



IoT IP Example

- Features of IP
 - Low-Power, Cost-Sensitive IoT,
 - Mobile, Automotive, Industrial and
 - Environmental Applications



Designware IP Subsystems

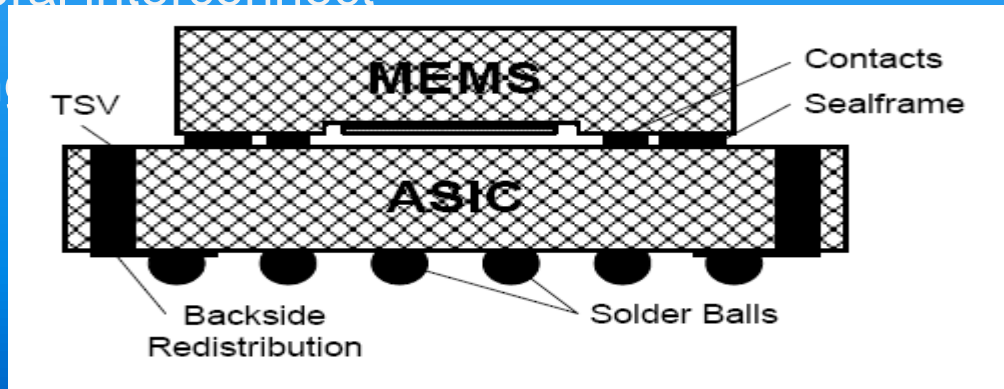
- Interface IP Subsystems
 - Configurable, customizable and pre-validated
 - DDR, PCIe, USB and Ethernet
- Audio IP Subsystems
 - Integrated HW and SW subsystem w/ “drop-in” functionality
 - 24-bit, DTV, STB
- Sensor and Control Subsystem
 - Integrated HW and SW subsystem
 - Complete, configurable to process D and A sensors etc



- **Background of IoT Tech:** Internet of Things
- **IoT and LPWAN:** NB-IoT, IPv6
- **IoT and MCU/IP:** Low Power & Size, 3D NAND
- **3D IC/MEMS/Wearable:** Healthcare/Medical, Fitness/Wellness
- **Discussion:** Vendors, Players

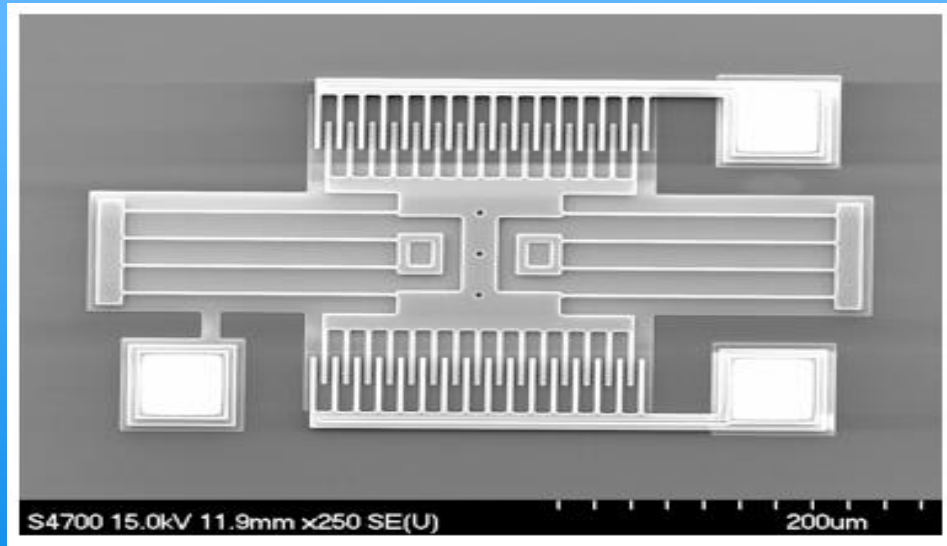
Advantage of 2.5D/3D Pkg'd MEMS/ASIC

- SiP support advanced three dimensional interconnect structure for MEMS and ASIC integration
 - Post-CMOS through-silicon vias (TSV)
 - Front-to-front contact array
 - Vacuum compliant lateral interconnect
 - Fine-pitch solder balling

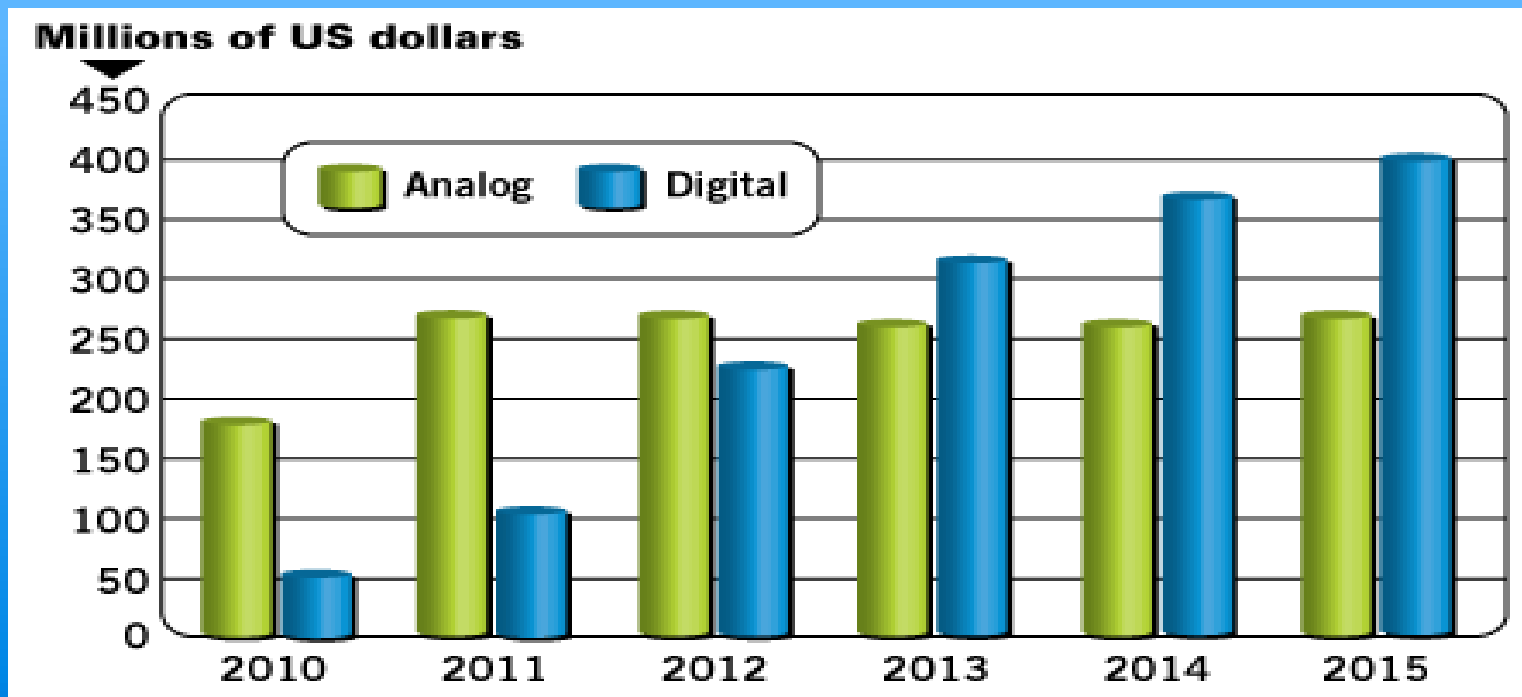


IoT and IC Design

- IoT Components
 - Sensors
 - **MEMS**
 - Other components



Digital MEMS microphones to overtake analog



Source: Solid State Technology, 2012

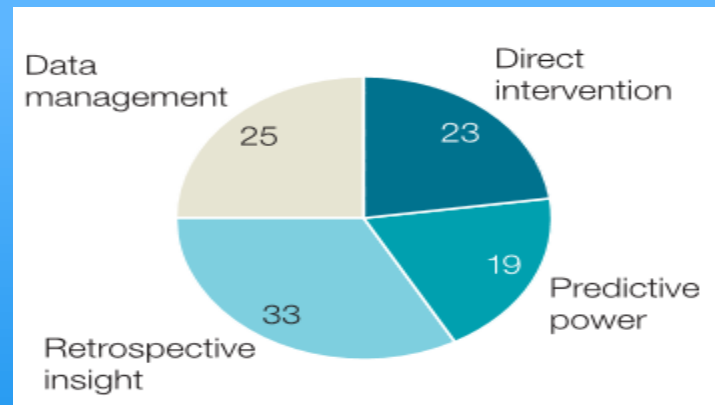
Wearable Market

- MEMS.journal: Market to expand 7x
- Statistics & Studies: It's all about the wrist
- Wearable Tech World: Market influencers ...
- By 2021, 5.05×10^6 wearable Devices are needed (Gartner)

Big Data and Medical

The big-data revolution in US health care

- Right living
- Right care
- Right provider
- Right value
- Right innovation



The biggest value of BD to humankind is medical

In 2014, semicon. patents reduced by 5%; according to Tangseng Luters “2015 Innov. Report”, pharm. and biotech patents increased by 12% and 7%!



- **Background of IoT Tech:** Internet of Things
- **IoT and LPWAN:** NB-IoT, IPv6
- **IoT and MCU/IP:** Low Power & Size, 3D NAND
- **3D IC/MEMS/Wearable:** Healthcare/Medical, Fitness/Wellness
- **Discussion:** Vendors, Players

Bluetooth (QCOM) and IoT

- BT: CSRmesh, aptX, cVc Noise Canc. Tech., TrueW-
- Wi-Fi: SoC (27 products), ex. QCA9994,
 - 802.11ac Wave 2; 11ac, 11n, 11a/b/g; 1.733Gbps; MIMO 4x4
- RF: TruSignal Antenna Boost Tech

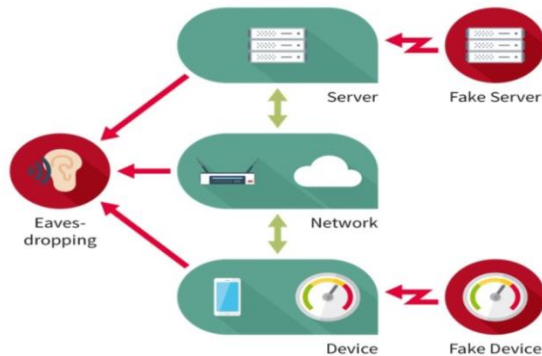
NB IoT ICs and Applications

- IoT IC Designers
 - Who are they?
- Potential Applications for NB IoT
 - Electric meters? Water? N Gas?
 - Smart parking meters/Street lamps?
 - Elevators IoT?
 - Smart logistics? S. Agriculture?
 - S. Manufacturing?
 - Garbage buckets? Hydrants?
 - S. home? S wearables? S construction? S. smoke detectors?

Security in IoT

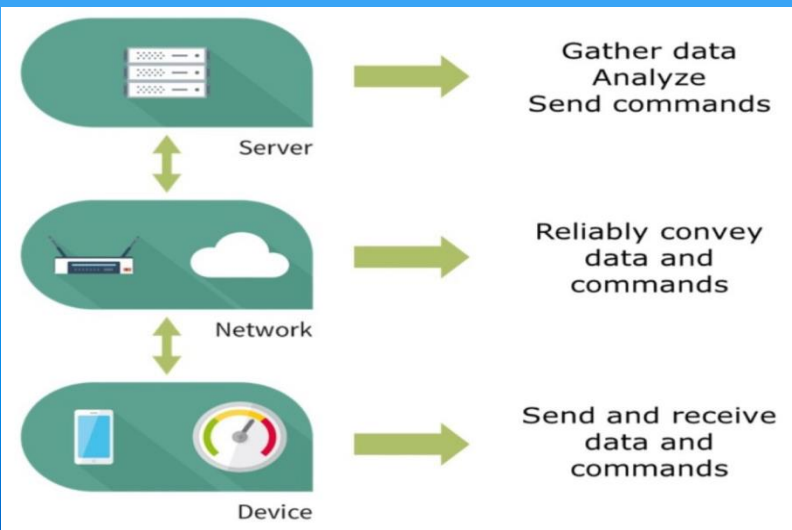
- Security matters
- Partners of choice
- Security solutions

An **Eavesdropper** listening in on data or commands can reveal confidential information about the operation of the infrastructure.



A **Fake Server** sending incorrect commands can be used to trigger unplanned events, to send some physical resource (water, oil, electricity, etc.) to an unplanned destination, and so forth.

A **Fake Device** injecting fake measurements can disrupt the control processes and cause them to react inappropriately or dangerously, or can be used to mask physical attacks.*





- **Background of IoT Tech:** Internet of Things
- **IoT and LPWAN:** NB-IoT, IPv6
- **IoT and MCU/IP:** Low Power & Size, 3D NAND
- **3D IC/MEMS/Wearable:** Healthcare/Medical, Fitness/Wellness
- **Discussion:** Vendors, Players

Cisco: Internet of Everything (IoE)

Samsung ARTIK

